



Welcome to [E-XFL.COM](#)

What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	ST7
Core Size	8-Bit
Speed	8MHz
Connectivity	I ² C, SCI, SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	48
Program Memory Size	60KB (60K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	3.8V ~ 5.5V
Data Converters	A/D 16x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/stmicroelectronics/st72f321bar9t6

Table of Contents

12.2.1	Voltage Characteristics	139
12.2.2	Current Characteristics	139
12.2.3	Thermal Characteristics	140
12.3	OPERATING CONDITIONS	140
12.3.1	General Operating Conditions	140
12.3.2	Operating Conditions with Low Voltage Detector (LVD)	141
12.3.3	Auxiliary Voltage Detector (AVD) Thresholds	141
12.3.4	External Voltage Detector (EVD) Thresholds	141
12.4	SUPPLY CURRENT CHARACTERISTICS	142
12.4.1	CURRENT CONSUMPTION	142
12.4.2	Supply and Clock Managers	143
12.4.3	On-Chip Peripherals	144
12.5	CLOCK AND TIMING CHARACTERISTICS	145
12.5.1	General Timings	145
12.5.2	External Clock Source	145
12.5.3	Crystal and Ceramic Resonator Oscillators	146
12.5.4	RC Oscillators	149
12.5.5	PLL Characteristics	150
12.6	MEMORY CHARACTERISTICS	151
12.6.1	RAM and Hardware Registers	151
12.6.2	FLASH Memory	151
12.7	EMC CHARACTERISTICS	152
12.7.1	Functional EMS (Electro Magnetic Susceptibility)	152
12.7.2	Electro Magnetic Interference (EMI)	153
12.7.3	Absolute Maximum Ratings (Electrical Sensitivity)	154
12.8	I/O PORT PIN CHARACTERISTICS	155
12.8.1	General Characteristics	155
12.8.2	Output Driving Current	156
12.9	CONTROL PIN CHARACTERISTICS	158
12.9.1	Asynchronous RESET Pin	158
12.9.2	ICCSEL/VPP Pin	160
12.10	TIMER PERIPHERAL CHARACTERISTICS	161
12.10.1	8-Bit PWM-ART Auto-Reload Timer	161
12.10.2	16-Bit Timer	161
12.11	COMMUNICATION INTERFACE CHARACTERISTICS	162
12.11.1	SPI - Serial Peripheral Interface	162
12.11.2	I2C - Inter IC Control Interface	164
12.12	10-BIT ADC CHARACTERISTICS	166
12.12.1	Analog Power Supply and Reference Pins	168
12.12.2	General PCB Design Guidelines	168
12.12.3	ADC Accuracy	169
13	PACKAGE CHARACTERISTICS	170
13.1	PACKAGE MECHANICAL DATA	170
13.2	THERMAL CHARACTERISTICS	172
13.3	SOLDERING INFORMATION	173
14	ST72321B DEVICE CONFIGURATION AND ORDERING INFORMATION	174

PIN DESCRIPTION (Cont'd)

For external pin connection guidelines, refer to See "ELECTRICAL CHARACTERISTICS" on page 138.

Legend / Abbreviations for Table 2 :

Type: I = input, O = output, S = supply

Input level: A = Dedicated analog input

In/Output level: C = CMOS 0.3V_{DD}/0.7V_{DD}
C_T = CMOS 0.3V_{DD}/0.7V_{DD} with input trigger
T_T = TTL 0.8V / 2V with Schmitt trigger

Output level: HS = 20mA high sink (on N-buffer only)

Port and control configuration:

- Input: float = floating, wpu = weak pull-up, int = interrupt ¹⁾, ana = analog
- Output: OD = open drain ²⁾, PP = push-pull

Refer to "I/O PORTS" on page 46 for more details on the software configuration of the I/O ports.

The RESET configuration of each pin is shown in bold. This configuration is valid as long as the device is in reset state.

Table 2. Device Pin Description

Pin n°			Pin Name	Type	Level		Port						Main function (after reset)	Alternate function
LQFP64	LQFP44	LQFP32			Input	Output	Input				Output			
							float	wpu	int	ana	OD	PP		
1	-	-	PE4 (HS)	I/O	C _T	HS	X	X			X	X	Port E4	
2	-	-	PE5 (HS)	I/O	C _T	HS	X	X			X	X	Port E5	
3	-	-	PE6 (HS)	I/O	C _T	HS	X	X			X	X	Port E6	
4	-	-	PE7 (HS)	I/O	C _T	HS	X	X			X	X	Port E7	
5	2	28	PB0/PWM3	I/O	C _T		X		ei2		X	X	Port B0	PWM Output 3
6	3	-	PB1/PWM2	I/O	C _T		X		ei2		X	X	Port B1	PWM Output 2
7	4	-	PB2/PWM1	I/O	C _T		X		ei2		X	X	Port B2	PWM Output 1
8	5	29	PB3/PWM0	I/O	C _T		X		ei2		X	X	Port B3	PWM Output 0
9	6	30	PB4 (HS)/ARTCLK	I/O	C _T	HS	X		ei3		X	X	Port B4	PWM-ART External Clock
10	-	-	PB5 / ARTIC1	I/O	C _T		X		ei3		X	X	Port B5	PWM-ART Input Capture 1
11	-	-	PB6 / ARTIC2	I/O	C _T		X		ei3		X	X	Port B6	PWM-ART Input Capture 2
12	-	-	PB7	I/O	C _T		X		ei3		X	X	Port B7	
13	7	31	PD0/AIN0	I/O	C _T		X	X		X	X	X	Port D0	ADC Analog Input 0
14	8	32	PD1/AIN1	I/O	C _T		X	X		X	X	X	Port D1	ADC Analog Input 1
15	9	-	PD2/AIN2	I/O	C _T		X	X		X	X	X	Port D2	ADC Analog Input 2
16	10	-	PD3/AIN3	I/O	C _T		X	X		X	X	X	Port D3	ADC Analog Input 3
17	11	-	PD4/AIN4	I/O	C _T		X	X		X	X	X	Port D4	ADC Analog Input 4
18	12	-	PD5/AIN5	I/O	C _T		X	X		X	X	X	Port D5	ADC Analog Input 5
19	-	-	PD6/AIN6	I/O	C _T		X	X		X	X	X	Port D6	ADC Analog Input 6
20	-	-	PD7/AIN7	I/O	C _T		X	X		X	X	X	Port D7	ADC Analog Input 7
21	13	1	V _{AREF}	I									Analog Reference Voltage for ADC	
22	14	2	V _{SSA}	S									Analog Ground Voltage	

SYSTEM INTEGRITY MANAGEMENT (Cont'd)**6.4.4 Register Description****SYSTEM INTEGRITY (SI) CONTROL/STATUS REGISTER (SICSR)**

Read/Write

Reset Value: 000x 000x (00h)

7							0
AVD S	AVD IE	AVD F	LVD RF	0	0	0	WDG RF

Bit 7 = AVDS Voltage Detection selection

This bit is set and cleared by software. Voltage Detection is available only if the LVD is enabled by option byte.

0: Voltage detection on V_{DD} supply

1: Voltage detection on EVD pin

Bit 6 = AVDIE Voltage Detector interrupt enable

This bit is set and cleared by software. It enables an interrupt to be generated when the AVDF flag changes (toggles). The pending interrupt information is automatically cleared when software enters the AVD interrupt routine.

0: AVD interrupt disabled

1: AVD interrupt enabled

Bit 5 = AVDF Voltage Detector flag

This read-only bit is set and cleared by hardware. If the AVDIE bit is set, an interrupt request is generated when the AVDF bit changes value. Refer to Figure 17 and to Section 6.4.2.1 for additional details.

0: V_{DD} or V_{EVD} over $V_{IT+(AVD)}$ threshold

1: V_{DD} or V_{EVD} under $V_{IT-(AVD)}$ threshold

Bit 4 = LVDRF LVD reset flag

This bit indicates that the last Reset was generated by the LVD block. It is set by hardware (LVD re-

set) and cleared by software (writing zero). See WDGRF flag description for more details. When the LVD is disabled by OPTION BYTE, the LVDRF bit value is undefined.

Bits 31 = Reserved, must be kept cleared.

Bit 0 = WDGRF Watchdog reset flag

This bit indicates that the last Reset was generated by the Watchdog peripheral. It is set by hardware (watchdog reset) and cleared by software (writing zero) or an LVD Reset (to ensure a stable cleared state of the WDGRF flag when CPU starts).

Combined with the LVDRF flag information, the flag description is given by the following table.

RESET Sources	LVDRF	WDGRF
External RESET pin	0	0
Watchdog	0	1
LVD	1	X

Application notes

The LVDRF flag is not cleared when another RESET type occurs (external or watchdog), the LVDRF flag remains set to keep trace of the original failure.

In this case, a watchdog reset can be detected by software while an external reset can not.

CAUTION: When the LVD is not activated with the associated option byte, the WDGRF flag can not be used in the application.

INTERRUPTS (Cont'd)

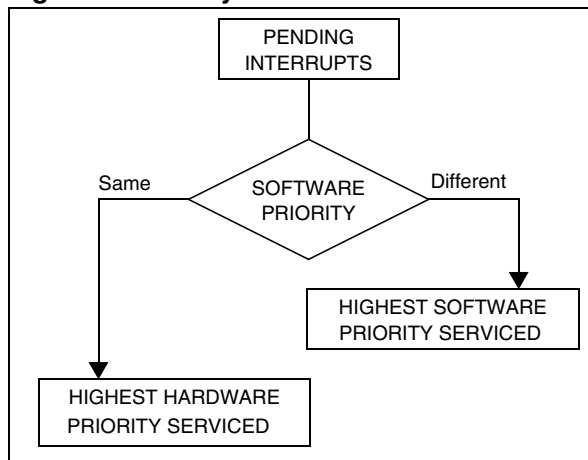
Servicing Pending Interrupts

As several interrupts can be pending at the same time, the interrupt to be taken into account is determined by the following two-step process:

- the highest software priority interrupt is serviced,
- if several interrupts have the same software priority then the interrupt with the highest hardware priority is serviced first.

Figure 20 describes this decision process.

Figure 20. Priority Decision Process



When an interrupt request is not serviced immediately, it is latched and then processed when its software priority combined with the hardware priority becomes the highest one.

Note 1: The hardware priority is exclusive while the software one is not. This allows the previous process to succeed with only one interrupt.

Note 2: TLI, RESET and TRAP can be considered as having the highest software priority in the decision process.

Different Interrupt Vector Sources

Two interrupt source types are managed by the ST7 interrupt controller: the non-maskable type (RESET, TRAP) and the maskable type (external or from internal peripherals).

Non-Maskable Sources

These sources are processed regardless of the state of the I1 and I0 bits of the CC register (see Figure 19). After stacking the PC, X, A and CC registers (except for RESET), the corresponding vector is loaded in the PC register and the I1 and I0 bits of the CC are set to disable interrupts (level 3). These sources allow the processor to exit HALT mode.

■ TRAP (Non Maskable Software Interrupt)

This software interrupt is serviced when the TRAP instruction is executed. It will be serviced according to the flowchart in Figure 19.

Caution: TRAP can be interrupted by a TLI.

■ RESET

The RESET source has the highest priority in the ST7. This means that the first current routine has the highest software priority (level 3) and the highest hardware priority.

See the RESET chapter for more details.

Maskable Sources

Maskable interrupt vector sources can be serviced if the corresponding interrupt is enabled and if its own interrupt software priority (in ISPRx registers) is higher than the one currently being serviced (I1 and I0 in CC register). If any of these two conditions is false, the interrupt is latched and thus remains pending.

■ TLI (Top Level Hardware Interrupt)

This hardware interrupt occurs when a specific edge is detected on the dedicated TLI pin. It will be serviced according to the flowchart in Figure 19 as a trap.

Caution: A TRAP instruction must not be used in a TLI service routine.

■ External Interrupts

External interrupts allow the processor to exit from HALT low power mode. External interrupt sensitivity is software selectable through the External Interrupt Control register (EICR).

External interrupt triggered on edge will be latched and the interrupt request automatically cleared upon entering the interrupt service routine.

If several input pins of a group connected to the same interrupt line are selected simultaneously, these will be logically ORed.

■ Peripheral Interrupts

Usually the peripheral interrupts cause the MCU to exit from HALT mode except those mentioned in the "Interrupt Mapping" table. A peripheral interrupt occurs when a specific flag is set in the peripheral status registers and if the corresponding enable bit is set in the peripheral control register.

The general sequence for clearing an interrupt is based on an access to the status register followed by a read or write to an associated register.

Note: The clearing sequence resets the internal latch. A pending interrupt (i.e. waiting for being serviced) will therefore be lost if the clear sequence is executed.

INTERRUPTS (Cont'd)

7.3 INTERRUPTS AND LOW POWER MODES

All interrupts allow the processor to exit the WAIT low power mode. On the contrary, only external and other specified interrupts allow the processor to exit from the HALT modes (see column “Exit from HALT” in “Interrupt Mapping” table). When several pending interrupts are present while exiting HALT mode, the first one serviced can only be an interrupt with exit from HALT mode capability and it is selected through the same decision process shown in Figure 20.

Note: If an interrupt, that is not able to Exit from HALT mode, is pending with the highest priority when exiting HALT mode, this interrupt is serviced after the first one serviced.

7.4 CONCURRENT & NESTED MANAGEMENT

The following Figure 21 and Figure 22 show two different interrupt management modes. The first is called concurrent mode and does not allow an interrupt to be interrupted, unlike the nested mode in Figure 22. The interrupt hardware priority is given in this order from the lowest to the highest: MAIN, IT4, IT3, IT2, IT1, IT0, TLI. The software priority is given for each interrupt.

Warning: A stack overflow may occur without notifying the software of the failure.

Figure 21. Concurrent Interrupt Management

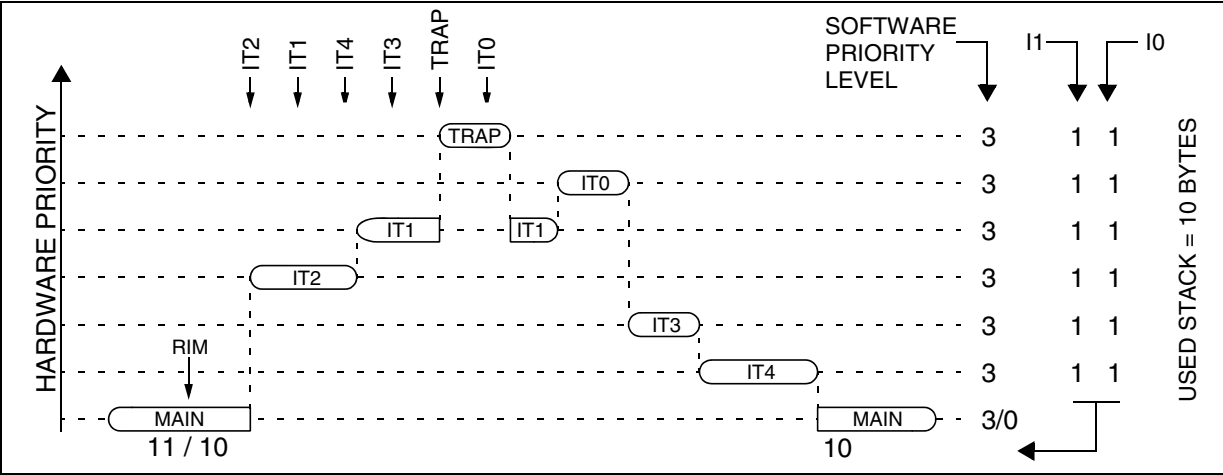
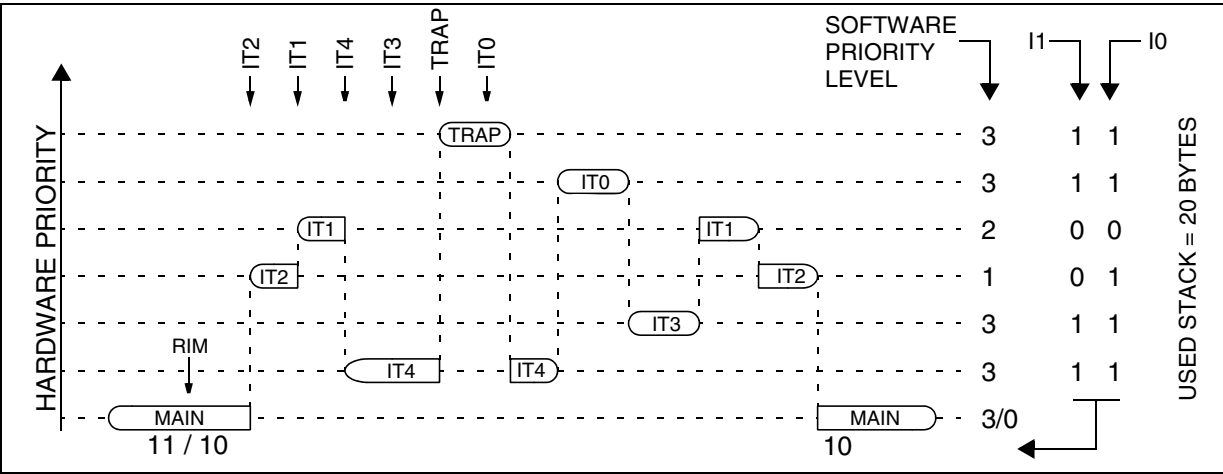


Figure 22. Nested Interrupt Management



WATCHDOG TIMER (Cont'd)

Figure 35. Exact Timeout Duration (t_{min} and t_{max})**WHERE:**

$$t_{min0} = (LSB + 128) \times 64 \times t_{OSC2}$$

$$t_{max0} = 16384 \times t_{OSC2}$$

$$t_{OSC2} = 125\text{ns if } f_{OSC2}=8\text{ MHz}$$

CNT = Value of T[5:0] bits in the WDGCR register (6 bits)

MSB and LSB are values from the table below depending on the timebase selected by the TB[1:0] bits in the MCCR register

TB1 Bit (MCCR Reg.)	TB0 Bit (MCCR Reg.)	Selected MCCR Timebase	MSB	LSB
0	0	2ms	4	59
0	1	4ms	8	53
1	0	10ms	20	35
1	1	25ms	49	54

To calculate the minimum Watchdog Timeout (t_{min}):

$$\text{IF } CNT < \left\lfloor \frac{MSB}{4} \right\rfloor \quad \text{THEN } t_{min} = t_{min0} + 16384 \times CNT \times t_{osc2}$$

$$\text{ELSE } t_{min} = t_{min0} + \left[16384 \times \left(CNT - \left\lfloor \frac{4CNT}{MSB} \right\rfloor \right) + (192 + LSB) \times 64 \times \left\lfloor \frac{4CNT}{MSB} \right\rfloor \right] \times t_{osc2}$$

To calculate the maximum Watchdog Timeout (t_{max}):

$$\text{IF } CNT \leq \left\lfloor \frac{MSB}{4} \right\rfloor \quad \text{THEN } t_{max} = t_{max0} + 16384 \times CNT \times t_{osc2}$$

$$\text{ELSE } t_{max} = t_{max0} + \left[16384 \times \left(CNT - \left\lfloor \frac{4CNT}{MSB} \right\rfloor \right) + (192 + LSB) \times 64 \times \left\lfloor \frac{4CNT}{MSB} \right\rfloor \right] \times t_{osc2}$$

Note: In the above formulae, division results must be rounded down to the next integer value.

Example:

With 2ms timeout selected in MCCR register

Value of T[5:0] Bits in WDGCR Register (Hex.)	Min. Watchdog Timeout (ms) t_{min}	Max. Watchdog Timeout (ms) t_{max}
00	1.496	2.048
3F	128	128.552

10.2 MAIN CLOCK CONTROLLER WITH REAL TIME CLOCK AND BEEPER (MCC/RTC)

The Main Clock Controller consists of three different functions:

- a programmable CPU clock prescaler
- a clock-out signal to supply external devices
- a real time clock timer with interrupt capability

Each function can be used independently and simultaneously.

10.2.1 Programmable CPU Clock Prescaler

The programmable CPU clock prescaler supplies the clock for the ST7 CPU and its internal peripherals. It manages SLOW power saving mode (See Section 8.2 SLOW MODE for more details).

The prescaler selects the f_{CPU} main clock frequency and is controlled by three bits in the MCCR register: CP[1:0] and SMS.

10.2.2 Clock-out Capability

The clock-out capability is an alternate function of an I/O port pin that outputs a f_{CPU} clock to drive

external devices. It is controlled by the MCO bit in the MCCR register.

CAUTION: When selected, the clock out pin suspends the clock during ACTIVE-HALT mode.

10.2.3 Real Time Clock Timer (RTC)

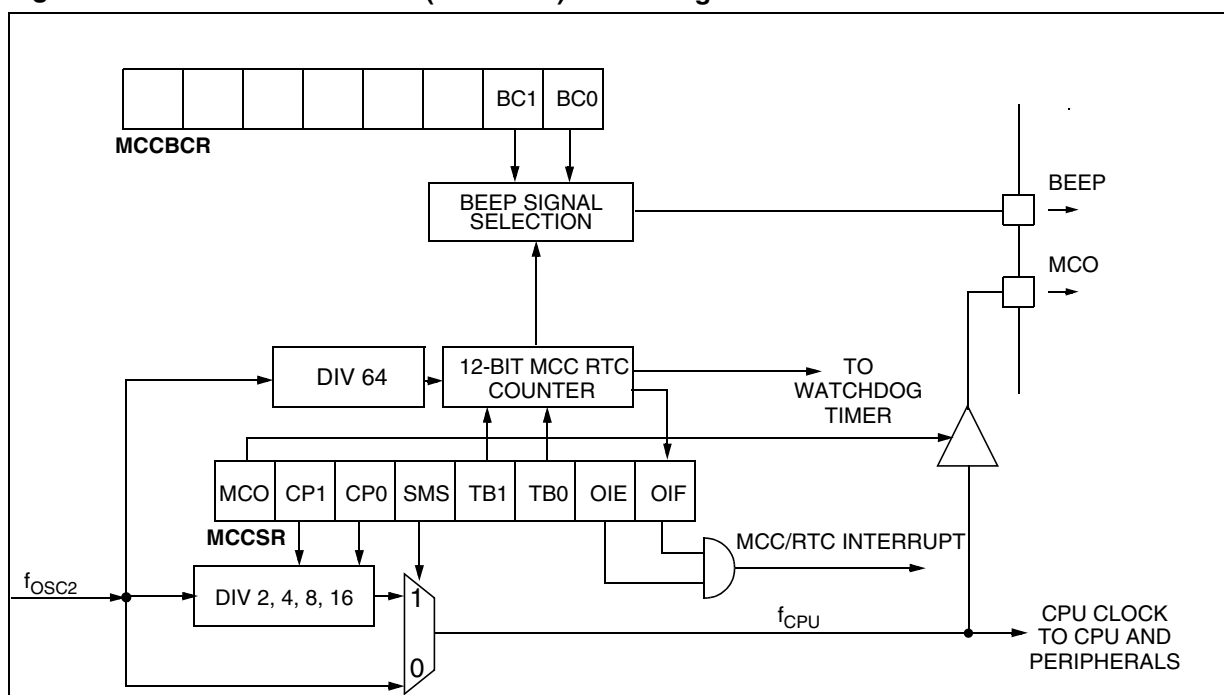
The counter of the real time clock timer allows an interrupt to be generated based on an accurate real time clock. Four different time bases depending directly on f_{OSC2} are available. The whole functionality is controlled by four bits of the MCCR register: TB[1:0], OIE and OIF.

When the RTC interrupt is enabled (OIE bit set), the ST7 enters ACTIVE-HALT mode when the HALT instruction is executed. See Section 8.4 ACTIVE-HALT AND HALT MODES for more details.

10.2.4 Beeper

The beep function is controlled by the MCCBCR register. It can output three selectable frequencies on the BEEP pin (I/O port alternate function).

Figure 36. Main Clock Controller (MCC/RTC) Block Diagram



MAIN CLOCK CONTROLLER WITH REAL TIME CLOCK (Cont'd)

Bit 0 = **OIF** *Oscillator interrupt flag*

This bit is set by hardware and cleared by software reading the MCCR register. It indicates when set that the main oscillator has reached the selected elapsed time (TB1:0).

0: Timeout not reached

1: Timeout reached

CAUTION: The BRES and BSET instructions must not be used on the MCCR register to avoid unintentionally clearing the OIF bit.

MCC BEEP CONTROL REGISTER (MCCBCR)

Read/Write

Reset Value: 0000 0000 (00h)

7						0	
0	0	0	0	0	0	BC1	BC0

Bit 7:2 = Reserved, must be kept cleared.

Bit 1:0 = **BC[1:0]** *Beep control*

These 2 bits select the PF1 pin beep capability.

BC1	BC0	Beep mode with $f_{OSC2}=8\text{MHz}$	
0	0	Off	
0	1	~2-KHz	Output Beep signal ~50% duty cycle
1	0	~1-KHz	
1	1	~500-Hz	

The beep output signal is available in ACTIVE-HALT mode but has to be disabled to reduce the consumption.

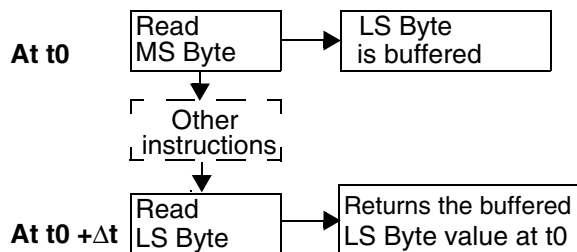
Table 15. Main Clock Controller Register Map and Reset Values

Address (Hex.)	Register Label	7	6	5	4	3	2	1	0
002Bh	SICSR Reset Value	AVDS 0	AVDIE 0	AVDF 0	LVDRF x	0	0	0	WDGRF x
002Ch	MCCSR Reset Value	MCO 0	CP1 0	CP0 0	SMS 0	TB1 0	TB0 0	OIE 0	OIF 0
002Dh	MCCBCR Reset Value	0	0	0	0	0	0	BC1 0	BC0 0

16-BIT TIMER (Cont'd)

16-bit read sequence: (from either the Counter Register or the Alternate Counter Register).

Beginning of the sequence



Sequence completed

The user must read the MS Byte first, then the LS Byte value is buffered automatically.

This buffered value remains unchanged until the 16-bit read sequence is completed, even if the user reads the MS Byte several times.

After a complete reading sequence, if only the CLR register or ACLR register are read, they return the LS Byte of the count value at the time of the read.

Whatever the timer mode used (input capture, output compare, One Pulse mode or PWM mode) an overflow occurs when the counter rolls over from FFFFh to 0000h then:

- The TOF bit of the SR register is set.
- A timer interrupt is generated if:
 - TOIE bit of the CR1 register is set and
 - I bit of the CC register is cleared.

If one of these conditions is false, the interrupt remains pending to be issued as soon as they are both true.

Clearing the overflow interrupt request is done in two steps:

1. Reading the SR register while the TOF bit is set.
2. An access (read or write) to the CLR register.

Notes: The TOF bit is not cleared by accesses to ACLR register. The advantage of accessing the ACLR register rather than the CLR register is that it allows simultaneous use of the overflow function and reading the free running counter at random times (for example, to measure elapsed time) without the risk of clearing the TOF bit erroneously.

The timer is not affected by WAIT mode.

In HALT mode, the counter stops counting until the mode is exited. Counting then resumes from the previous count (MCU awakened by an interrupt) or from the reset count (MCU awakened by a Reset).

10.4.3.2 External Clock

The external clock (where available) is selected if CC0 = 1 and CC1 = 1 in the CR2 register.

The status of the EXEDG bit in the CR2 register determines the type of level transition on the external clock pin EXTCLK that will trigger the free running counter.

The counter is synchronized with the falling edge of the internal CPU clock.

A minimum of four falling edges of the CPU clock must occur between two consecutive active edges of the external clock; thus the external clock frequency must be less than a quarter of the CPU clock frequency.

16-BIT TIMER (Cont'd)

Figure 44. Counter Timing Diagram, Internal Clock Divided by 2

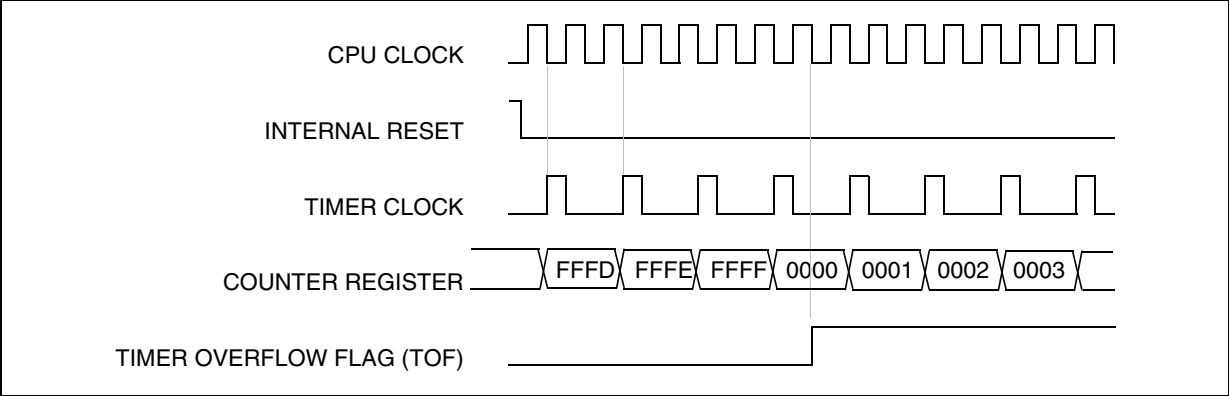


Figure 45. Counter Timing Diagram, Internal Clock Divided by 4

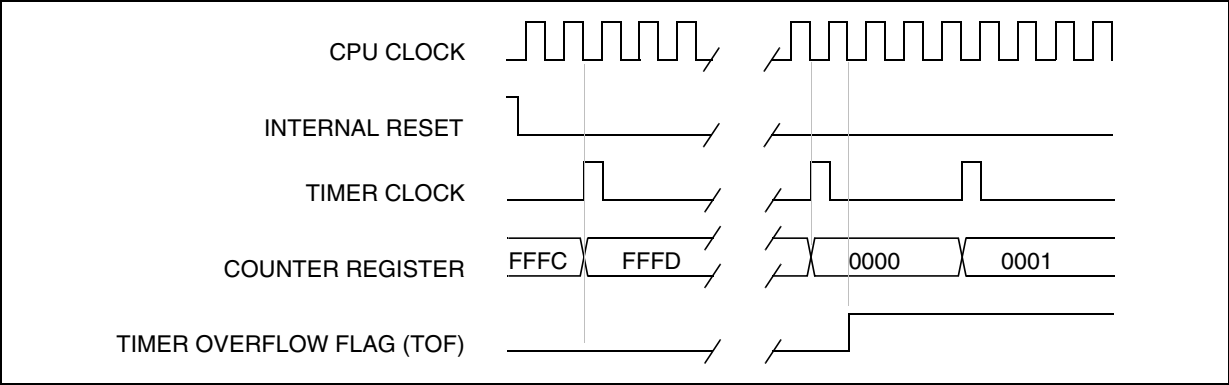
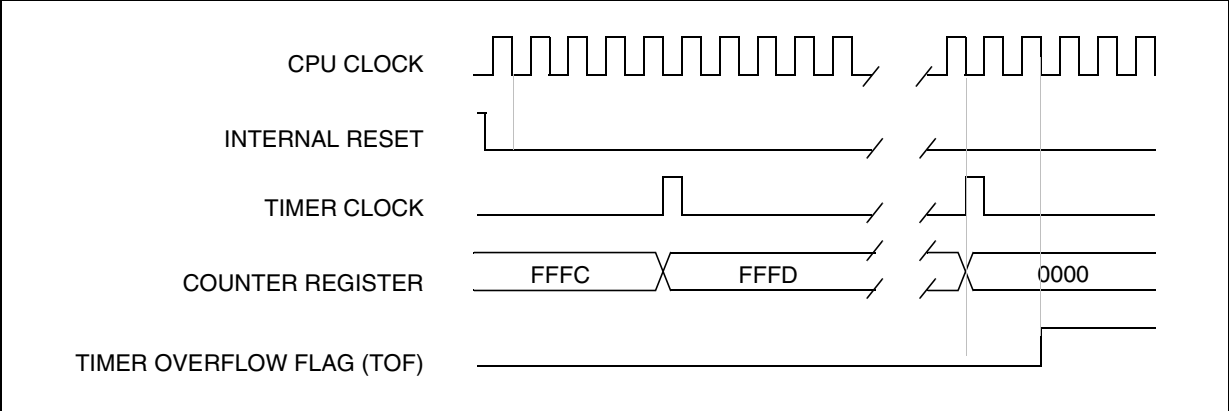


Figure 46. Counter Timing Diagram, Internal Clock Divided By 8



Note: The MCU is in reset state when the internal reset signal is high, when it is low the MCU is running.

16-BIT TIMER (Cont'd)**10.4.3.5 One Pulse Mode**

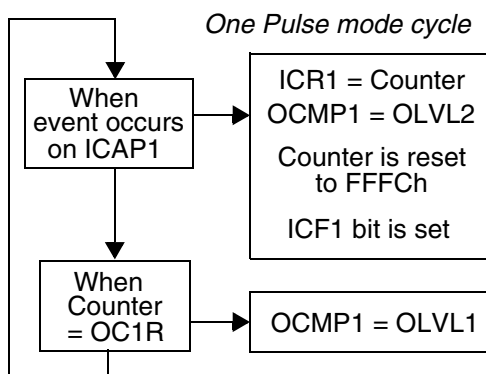
One Pulse mode enables the generation of a pulse when an external event occurs. This mode is selected via the OPM bit in the CR2 register.

The One Pulse mode uses the Input Capture1 function and the Output Compare1 function.

Procedure:

To use One Pulse mode:

1. Load the OC1R register with the value corresponding to the length of the pulse (see the formula in the opposite column).
2. Select the following in the CR1 register:
 - Using the OLVL1 bit, select the level to be applied to the OCMP1 pin after the pulse.
 - Using the OLVL2 bit, select the level to be applied to the OCMP1 pin during the pulse.
 - Select the edge of the active transition on the ICAP1 pin with the IEDG1 bit (the ICAP1 pin must be configured as floating input).
3. Select the following in the CR2 register:
 - Set the OC1E bit, the OCMP1 pin is then dedicated to the Output Compare 1 function.
 - Set the OPM bit.
 - Select the timer clock CC[1:0] (see Table 1).



Then, on a valid event on the ICAP1 pin, the counter is initialized to FFFCh and OLVL2 bit is loaded on the OCMP1 pin, the ICF1 bit is set and the value FFFDh is loaded in the IC1R register.

Because the ICF1 bit is set when an active edge occurs, an interrupt can be generated if the ICIE bit is set.

Clearing the Input Capture interrupt request (that is, clearing the ICF1 bit) is done in two steps:

1. Reading the SR register while the ICF1 bit is set.
2. An access (read or write) to the IC1LR register.

The OC1R register value required for a specific timing application can be calculated using the following formula:

$$\text{OC1R Value} = \frac{t \cdot f_{\text{CPU}}}{\text{PRESC}} - 5$$

Where:

t = Pulse period (in seconds)

f_{CPU} = CPU clock frequency (in hertz)

PRESC = Timer prescaler factor (2, 4 or 8 depending on the CC[1:0] bits, see Table 1)

If the timer clock is an external clock the formula is:

$$\text{OC1R} = t \cdot f_{\text{EXT}} - 5$$

Where:

t = Pulse period (in seconds)

f_{EXT} = External timer clock frequency (in hertz)

When the value of the counter is equal to the value of the contents of the OC1R register, the OLVL1 bit is output on the OCMP1 pin, (See Figure 10).

Notes:

1. The OCF1 bit cannot be set by hardware in One Pulse mode but the OCF2 bit can generate an Output Compare interrupt.
2. When the Pulse Width Modulation (PWM) and One Pulse mode (OPM) bits are both set, the PWM mode is the only active one.
3. If OLVL1 = OLVL2 a continuous signal will be seen on the OCMP1 pin.
4. The ICAP1 pin can not be used to perform input capture. The ICAP2 pin can be used to perform input capture (ICF2 can be set and IC2R can be loaded) but the user must take care that the counter is reset each time a valid edge occurs on the ICAP1 pin and ICF1 can also generates interrupt if ICIE is set.
5. When One Pulse mode is used OC1R is dedicated to this mode. Nevertheless OC2R and OCF2 can be used to indicate a period of time has been elapsed but cannot generate an output waveform because the level OLVL2 is dedicated to the One Pulse mode.

16-BIT TIMER (Cont'd)

Figure 52. One Pulse Mode Timing Example

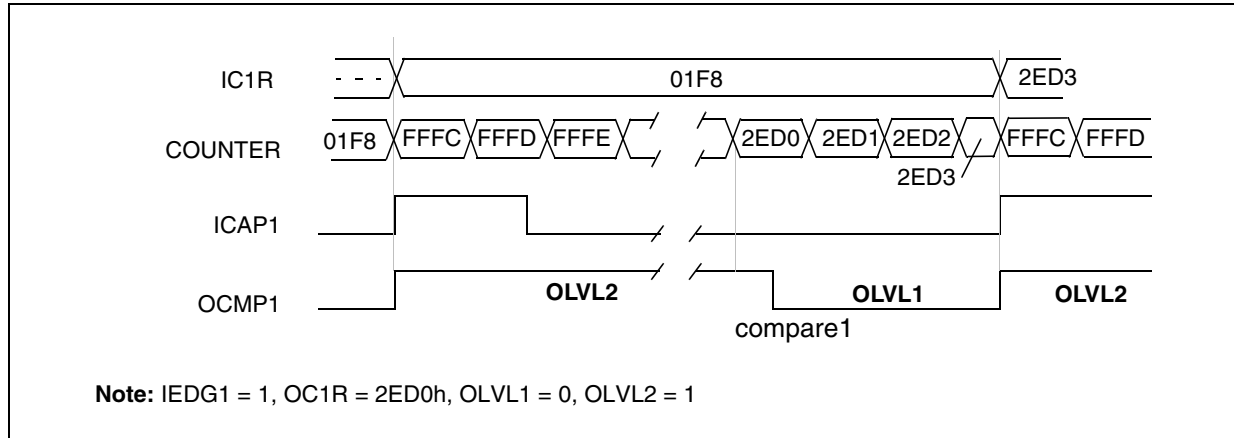
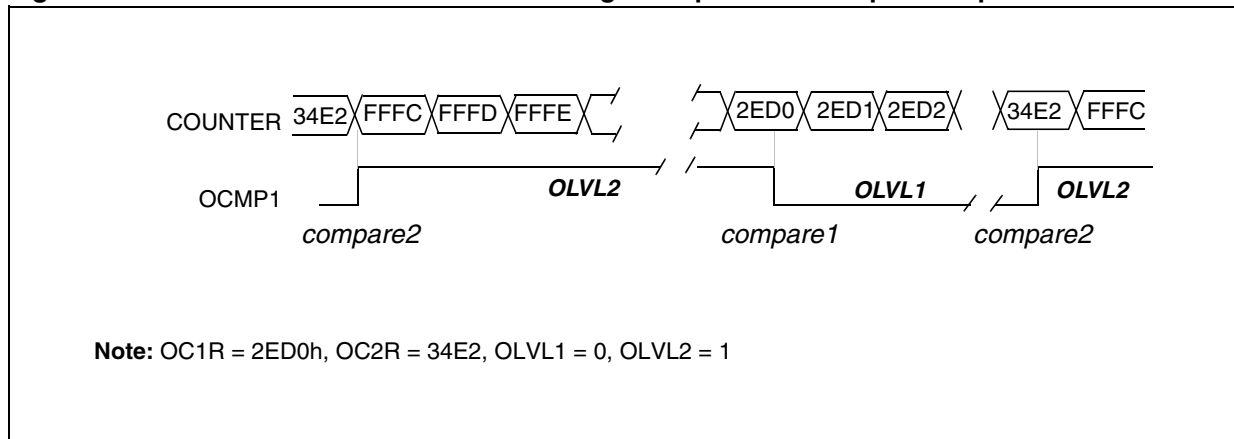


Figure 53. Pulse Width Modulation Mode Timing Example with 2 Output Compare Functions



Note: On timers with only one Output Compare register, a fixed frequency PWM signal can be generated using the output compare and the counter overflow to define the pulse length.

SERIAL PERIPHERAL INTERFACE (Cont'd)– $\overline{SS}$: Slave select:

This input signal acts as a 'chip select' to let the SPI master communicate with slaves individually and to avoid contention on the data lines. Slave $\overline{SS}$ inputs can be driven by standard I/O ports on the master MCU.

10.5.3.1 Functional Description

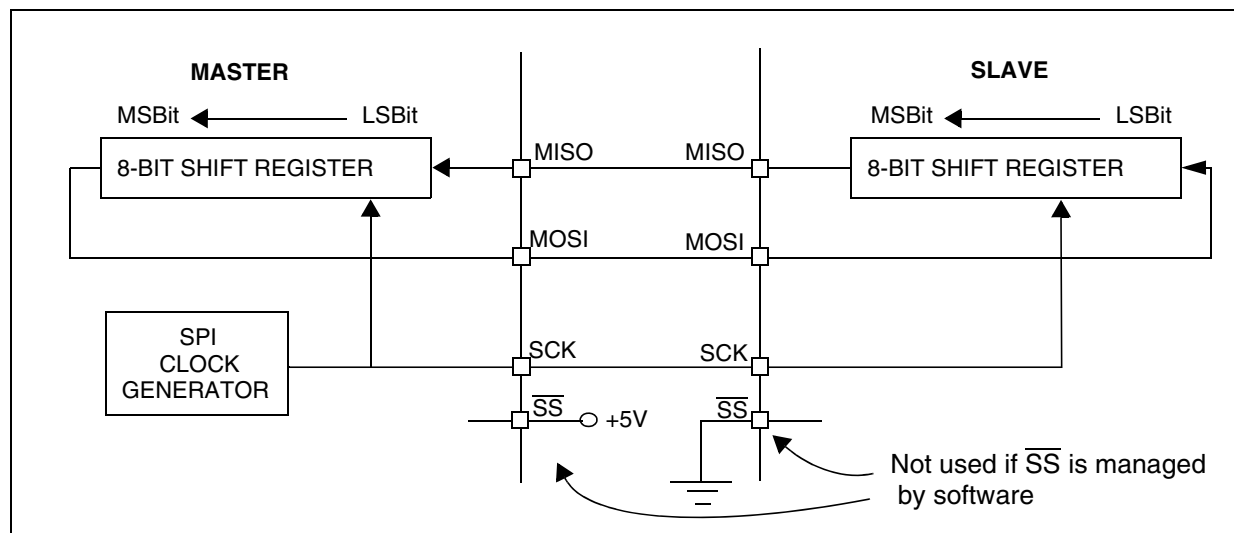
A basic example of interconnections between a single master and a single slave is illustrated in Figure 55.

The MOSI pins are connected together and the MISO pins are connected together. In this way data is transferred serially between master and slave (most significant bit first).

The communication is always initiated by the master. When the master device transmits data to a slave device via MOSI pin, the slave device responds by sending data to the master device via the MISO pin. This implies full duplex communication with both data out and data in synchronized with the same clock signal (which is provided by the master device via the SCK pin).

To use a single data line, the MISO and MOSI pins must be connected at each node (in this case only simplex communication is possible).

Four possible data/clock timing relationships may be chosen (see Figure 58) but master and slave must be programmed with the same timing mode.

Figure 55. Single Master/ Single Slave Application

SERIAL COMMUNICATIONS INTERFACE (Cont'd)**10.6.4.3 Receiver**

The SCI can receive data words of either 8 or 9 bits. When the M bit is set, word length is 9 bits and the MSB is stored in the R8 bit in the SCICR1 register.

Character reception

During a SCI reception, data shifts in least significant bit first through the RDI pin. In this mode, the SCIDR register consists of a buffer (RDR) between the internal bus and the received shift register (see Figure 1.).

Procedure

- Select the M bit to define the word length.
- Select the desired baud rate using the SCIBRR and the SCIERPR registers.
- Set the RE bit, this enables the receiver which begins searching for a start bit.

When a character is received:

- The RDRF bit is set. It indicates that the content of the shift register is transferred to the RDR.
- An interrupt is generated if the RIE bit is set and the I bit is cleared in the CCR register.
- The error flags can be set if a frame error, noise or an overrun error has been detected during reception.

Clearing the RDRF bit is performed by the following software sequence done by:

1. An access to the SCISR register
2. A read to the SCIDR register.

The RDRF bit must be cleared before the end of the reception of the next character to avoid an overrun error.

Break Character

When a break character is received, the SCI handles it as a framing error.

Idle Character

When an idle frame is detected, there is the same procedure as a data received character plus an interrupt if the ILIE bit is set and the I bit is cleared in the CCR register.

Overrun Error

An overrun error occurs when a character is received when RDRF has not been reset. Data can not be transferred from the shift register to the

RDR register as long as the RDRF bit is not cleared.

When an overrun error occurs:

- The OR bit is set.
- The RDR content is not lost.
- The shift register is overwritten.
- An interrupt is generated if the RIE bit is set and the I bit is cleared in the CCR register.

The OR bit is reset by an access to the SCISR register followed by a SCIDR register read operation.

Noise Error

Oversampling techniques are used for data recovery by discriminating between valid incoming data and noise. Normal data bits are considered valid if three consecutive samples (8th, 9th, 10th) have the same bit value, otherwise the NF flag is set. In the case of start bit detection, the NF flag is set on the basis of an algorithm combining both valid edge detection and three samples (8th, 9th, 10th). Therefore, to prevent the NF flag getting set during start bit reception, there should be a valid edge detection as well as three valid samples.

When noise is detected in a frame:

- The NF flag is set at the rising edge of the RDRF bit.
- Data is transferred from the Shift register to the SCIDR register.
- No interrupt is generated. However this bit rises at the same time as the RDRF bit which itself generates an interrupt.

The NF flag is reset by a SCISR register read operation followed by a SCIDR register read operation.

During reception, if a false start bit is detected (e.g. 8th, 9th, 10th samples are 011,101,110), the frame is discarded and the receiving sequence is not started for this frame. There is no RDRF bit set for this frame and the NF flag is set internally (not accessible to the user). This NF flag is accessible along with the RDRF bit when a next valid frame is received.

Note: If the application Start Bit is not long enough to match the above requirements, then the NF Flag may get set due to the short Start Bit. In this case, the NF flag may be ignored by the application software when the first valid byte is received.

See also Section 0.1.4.10 .

SERIAL COMMUNICATIONS INTERFACE (Cont'd)**CONTROL REGISTER 1 (SCICR1)**

Read/Write

Reset Value: x000 0000 (x0h)

7							0
R8	T8	SCID	M	WAKE	PCE	PS	PIE

Bit 7 = R8 *Receive data bit 8.*

This bit is used to store the 9th bit of the received word when M = 1.

Bit 6 = T8 *Transmit data bit 8.*

This bit is used to store the 9th bit of the transmitted word when M = 1.

Bit 5 = SCID *Disabled for low power consumption*
 When this bit is set the SCI prescalers and outputs are stopped and the end of the current byte transfer in order to reduce power consumption. This bit is set and cleared by software.

0: SCI enabled

1: SCI prescaler and outputs disabled

Bit 4 = M *Word length.*

This bit determines the word length. It is set or cleared by software.

0: 1 Start bit, 8 Data bits, 1 Stop bit

1: 1 Start bit, 9 Data bits, 1 Stop bit

Note: The M bit must not be modified during a data transfer (both transmission and reception).

Bit 3 = WAKE *Wake-Up method.*

This bit determines the SCI Wake-Up method, it is set or cleared by software.

0: Idle Line

1: Address Mark

Bit 2 = PCE *Parity control enable.*

This bit selects the hardware parity control (generation and detection). When the parity control is enabled, the computed parity is inserted at the MSB position (9th bit if M = 1; 8th bit if M = 0) and parity is checked on the received data. This bit is set and cleared by software. Once it is set, PCE is active after the current byte (in reception and in transmission).

0: Parity control disabled

1: Parity control enabled

Bit 1 = PS *Parity selection.*

This bit selects the odd or even parity when the parity generation/detection is enabled (PCE bit set). It is set and cleared by software. The parity is selected after the current byte.

0: Even parity

1: Odd parity

Bit 0 = PIE *Parity interrupt enable.*

This bit enables the interrupt capability of the hardware parity control when a parity error is detected (PE bit set). It is set and cleared by software.

0: Parity error interrupt disabled

1: Parity error interrupt enabled.

I²C BUS INTERFACE (Cont'd)**I²C CLOCK CONTROL REGISTER (CCR)**

Read / Write

Reset Value: 0000 0000 (00h)

7							0
FM/SM	CC6	CC5	CC4	CC3	CC2	CC1	CC0

Bit 7 = **FM/SM** *Fast/Standard I²C mode*.

This bit is set and cleared by software. It is not cleared when the interface is disabled (PE=0).

0: Standard I²C mode1: Fast I²C modeBit 6:0 = **CC[6:0]** *7-bit clock divider*.These bits select the speed of the bus (F_{SCL}) depending on the I²C mode. They are not cleared when the interface is disabled (PE=0).

Refer to the Electrical Characteristics section for the table of values.

Note: The programmed F_{SCL} assumes no load on SCL and SDA lines.**I²C DATA REGISTER (DR)**

Read / Write

Reset Value: 0000 0000 (00h)

7							0
D7	D6	D5	D4	D3	D2	D1	D0

Bit 7:0 = **D[7:0]** *8-bit Data Register*.

These bits contain the byte to be received or transmitted on the bus.

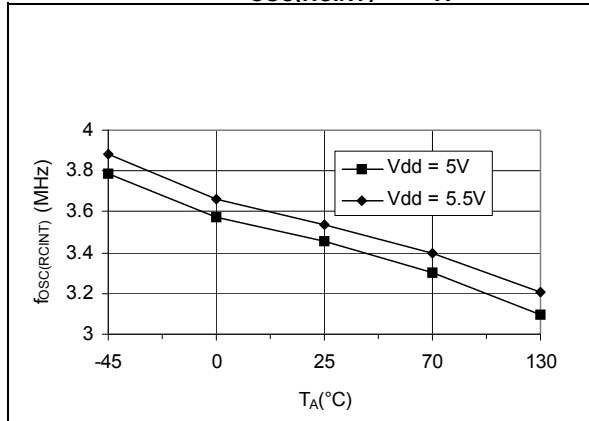
- Transmitter mode: Byte transmission start automatically when the software writes in the DR register.

- Receiver mode: the first data byte is received automatically in the DR register using the least significant bit of the address.

Then, the following data bytes are received one by one after reading the DR register.

CLOCK CHARACTERISTICS (Cont'd)**12.5.4 RC Oscillators**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$f_{\text{OSC (RCINT)}}$	Internal RC oscillator frequency See Figure 76	$T_A = 25^\circ\text{C}$, $V_{\text{DD}} = 5\text{V}$	2	3.5	5.6	MHz

Figure 76. Typical $f_{\text{OSC(RCINT)}}$ vs T_A 

Note: To reduce disturbance to the RC oscillator, it is recommended to place decoupling capacitors between V_{DD} and V_{SS} as shown in Figure 96

I/O PORT PIN CHARACTERISTICS (Cont'd)

Figure 83. Typical V_{OL} vs. V_{DD} (standard)

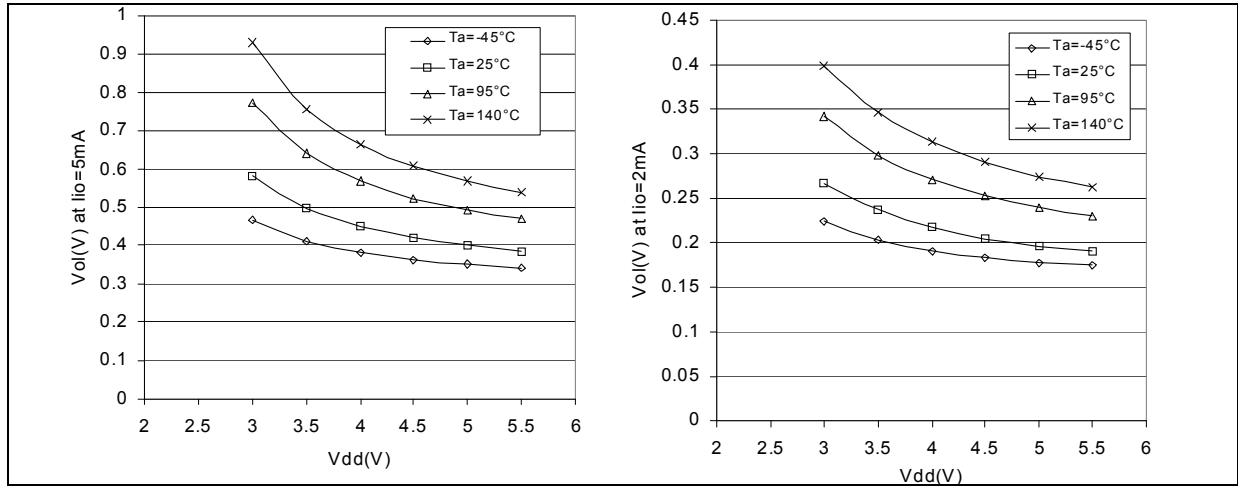


Figure 84. Typical V_{OL} vs. V_{DD} (high-sink)

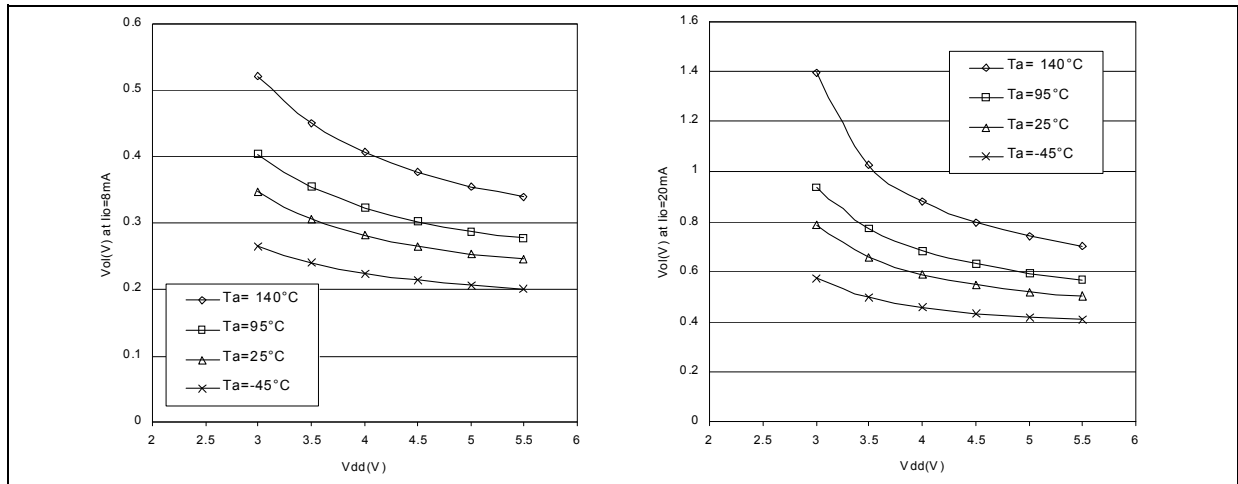
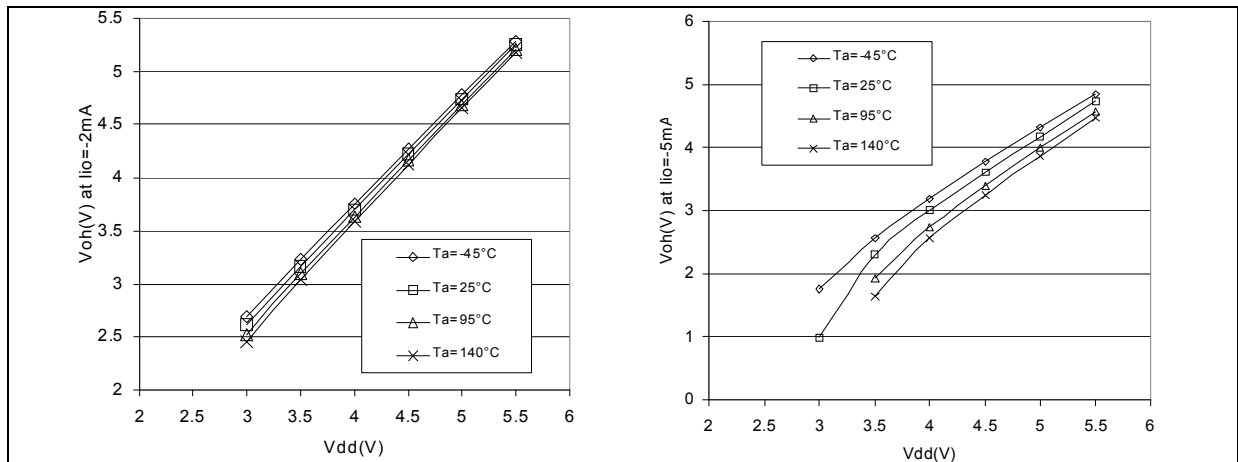


Figure 85. Typical $V_{DD} - V_{OH}$ vs. V_{DD}



15 KNOWN LIMITATIONS

15.1 ALL DEVICES

15.1.1 Unexpected Reset Fetch

If an interrupt request occurs while a “POP CC” instruction is executed, the interrupt controller does not recognise the source of the interrupt and, by default, passes the RESET vector address to the CPU.

Workaround

To solve this issue, a “POP CC” instruction must always be preceded by a “SIM” instruction.

15.1.2 External interrupt missed

To avoid any risk if generating a parasitic interrupt, the edge detector is automatically disabled for one clock cycle during an access to either DDR and OR. Any input signal edge during this period will not be detected and will not generate an interrupt.

This case can typically occur if the application refreshes the port configuration registers at intervals during runtime.

Workaround

The workaround is based on software checking the level on the interrupt pin before and after writing to the PxOR or PxDDR registers. If there is a level change (depending on the sensitivity programmed for this pin) the interrupt routine is invoked using the call instruction with three extra PUSH instructions before executing the interrupt routine (this is to make the call compatible with the IRET instruction at the end of the interrupt service routine).

But detection of the level change does not make sure that edge occurs during the critical 1 cycle duration and the interrupt has been missed. This may lead to occurrence of same interrupt twice (one hardware and another with software call).

To avoid this, a semaphore is set to '1' before checking the level change. The semaphore is changed to level '0' inside the interrupt routine. When a level change is detected, the semaphore status is checked and if it is '1' this means that the last interrupt has been missed. In this case, the interrupt routine is invoked with the call instruction.

There is another possible case i.e. if writing to PxOR or PxDDR is done with global interrupts disabled (interrupt mask bit set). In this case, the semaphore is changed to '1' when the level change is detected. Detecting a missed interrupt is done after the global interrupts are enabled (interrupt mask bit reset) and by checking the status of

the semaphore. If it is '1' this means that the last interrupt was missed and the interrupt routine is invoked with the call instruction.

To implement the workaround, the following software sequence is to be followed for writing into the PxOR/PxDDR registers. The example is for Port PF1 with falling edge interrupt sensitivity. The software sequence is given for both cases (global interrupt disabled/enabled).

Case 1: Writing to PxOR or PxDDR with Global Interrupts Enabled:

```
LD A,#01
LD sema,A      ; set the semaphore to '1'
LD A,PFDR
AND A,#02
LD X,A          ; store the level before writing to
PxOR/PxDDR
LD A,$90
LD PFDDR,A     ; Write to PFDDR
LD A,$ff
LD PFOR,A      ; Write to PFOR
LD A,PFDR
AND A,#02
LD Y,A          ; store the level after writing to
PxOR/PxDDR
LD A,X          ; check for falling edge
cp A,#02
jne OUT
TNZ Y
jne OUT
LD A,sema      ; check the semaphore status if
edge is detected
CP A,#01
jne OUT
call call_routine; call the interrupt routine
OUT:LD A,#00
LD sema,A
.call_routine  ; entry to call_routine
PUSH A
PUSH X
PUSH CC
.ext1_rt      ; entry to interrupt routine
LD A,#00
```

16 REVISION HISTORY

Table 32. Revision History

Date	Revision	Description of Changes
21-Mar-2006	2	Added "32-Pin LQFP Package Pinout" on page 10 Removed CSS feature in "SYSTEM INTEGRITY MANAGEMENT (SI)" on page 29. Updated "DEVICE ORDERING INFORMATION AND TRANSFER OF CUSTOMER CODE" on page 177 Updated "KNOWN LIMITATIONS" on page 186
10-Apr-2006	3	Removed blank pages
10-Apr-2007	4	In Table 2 added note for I/O Port E2 (PE2) output mode "pull-up always activated" Deleted the sentence in Section 4.3.1 'Readout protection is not supported if LVD is enabled' In Section 10.4 16-bit timer, replaced text in note 3 with "In both internal and external clock modes, OCFi and OCMPi are set while the counter value equals the OCiR register value (see Figure 50 for an example with fCPU/2 and Figure 51 for an example with fCPU/4). This behavior is the same in OPM or PWM mode." Removed Compare Register i Latch signal from Figure 51. Removed EMC protective circuitry in Figure 87 on page 159 (device works correctly without these components) Changed Footnote 4 in Section 12.11.1 Added 'TIMD set simultaneously with OC interrupt' in Section 15.1.2 Added 'Pull-up always active on PE2' in Section 15.1.8 Deleted limitations 'Halt ActiveHalt Power consumption' 'I2C interrupt exit from Halt/Active-Halt' and Safe connection of OSC1/OSC2 pins' in Section 15
13-Oct-2008	5	Title of the document changed Modified "Starting the Conversion" on page 129 Modified t_{RET} and N_{RW} values in "FLASH Memory" on page 151 Modified "Absolute Maximum Ratings (Electrical Sensitivity)" on page 154 Values in inches rounded to 4 decimal digits (instead of 3) in "PACKAGE MECHANICAL DATA" on page 170 Modified "PACKAGE CHARACTERISTICS" on page 170 (Section 13.3) Modified "TIMD set simultaneously with OC interrupt" on page 185 Modified Section 14.2 DEVICE ORDERING INFORMATION AND TRANSFER OF CUSTOMER CODE on page 176 (Figure 102 and option list)